**Preferred Device** 

# Small Signal MOSFET 200 mAmps, 60 Volts

N-Channel TO-92

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain Source Voltage	VDSS	60	Vdc
Drain–Gate Voltage ( $R_{GS}$ = 1.0 M $\Omega$ )	VDGR	60	Vdc
Gate–Source Voltage – Continuous – Non–repetitive (t <sub>p</sub> ≤ 50 μs)	V <sub>GS</sub> V <sub>GSM</sub>	±20 ±40	Vdc Vpk
Drain Current – Continuous – Pulsed	I <sub>D</sub> I <sub>DM</sub>	200 500	mAdc
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	350 2.8	mW mW/°C
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

#### THERMAL CHARACTERISTICS

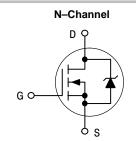
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	357	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/16" from case for 10 seconds	ΤL	300	°C



### **ON Semiconductor**

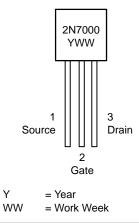
http://onsemi.com

200 mAMPS 60 VOLTS RDS(on) = 5 Ω





MARKING DIAGRAM & PIN ASSIGNMENT



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

## **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

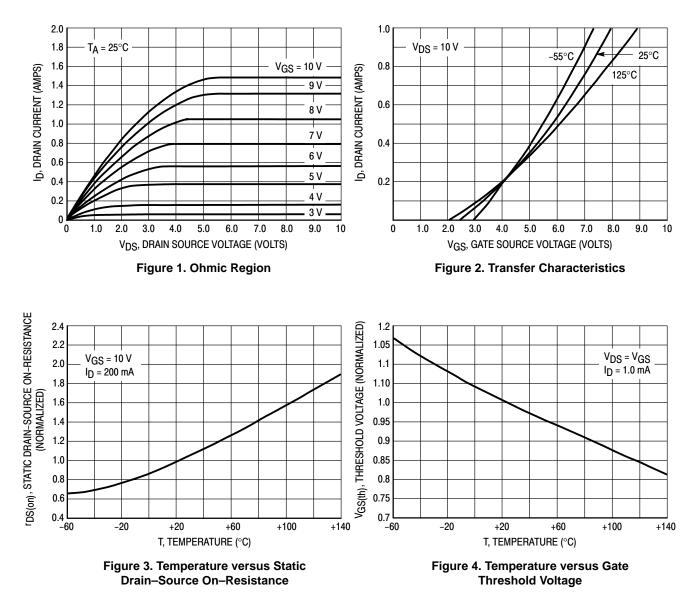
Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS	· · ·		•	÷
Drain–Source Breakdown Voltage $(V_{GS} = 0, I_D = 10 \mu Adc)$	V(BR)DSS	60	-	Vdc
Zero Gate Voltage Drain Current $(V_{DS} = 48 \text{ Vdc}, V_{GS} = 0)$ $(V_{DS} = 48 \text{ Vdc}, V_{GS} = 0, T_J = 125^{\circ}C)$	IDSS		1.0 1.0	μAdc mAdc
Gate–Body Leakage Current, Forward (V <sub>GSF</sub> = 15 Vdc, V <sub>DS</sub> = 0)	IGSSF	-	-10	nAdc
ON CHARACTERISTICS (Note 1.)				
Gate Threshold Voltage $(V_{DS} = V_{GS}, I_D = 1.0 \text{ mAdc})$	V <sub>GS(th)</sub>	0.8	3.0	Vdc
Static Drain–Source On–Resistance ( $V_{GS}$ = 10 Vdc, $I_D$ = 0.5 Adc) ( $V_{GS}$ = 4.5 Vdc, $I_D$ = 75 mAdc)	<sup>r</sup> DS(on)		5.0 6.0	Ohm
Drain–Source On–Voltage (V <sub>GS</sub> = 10 Vdc, $I_D$ = 0.5 Adc) (V <sub>GS</sub> = 4.5 Vdc, $I_D$ = 75 mAdc)	VDS(on)		2.5 0.45	Vdc
On–State Drain Current (V <sub>GS</sub> = 4.5 Vdc, V <sub>DS</sub> = 10 Vdc)	ld(on)	75	-	mAdc
Forward Transconductance $(V_{DS} = 10 \text{ Vdc}, I_D = 200 \text{ mAdc})$	9fs	100	-	μmhos
DYNAMIC CHARACTERISTICS			-	+

Input Capacitance		C <sub>iss</sub>	-	60	pF
Output Capacitance	$(V_{DS} = 25 V, V_{GS} = 0,$	C <sub>OSS</sub>	-	25	
Reverse Transfer Capacitance	f = 1.0 MHz)	C <sub>rss</sub>	-	5.0	

#### SWITCHING CHARACTERISTICS (Note 1.)

Turn–On Delay Time	(V <sub>DD</sub> = 15 V, I <sub>D</sub> = 500 mA,	ton	-	10	ns
Turn-Off Delay Time	$R_G = 25 \Omega$ , $R_L = 30 \Omega$ , $V_{gen} = 10 V$ )	toff	-	10	

1. Pulse Test: Pulse Width  $\leq 300~\mu s,$  Duty Cycle  $\leq 2.0\%.$ 

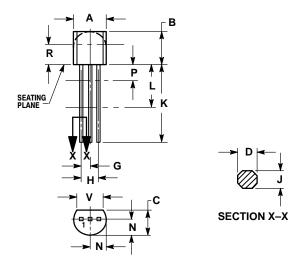


### **ORDERING INFORMATION**

Device	Package	Shipping
2N7000	TO-92	1000 Unit/Box
2N7000RLRA	TO-92	2000 Tape & Reel
2N7000RLRM	TO-92	2000 Ammo Pack
2N7000RLRP	TO-92	2000 Ammo Pack
2N7000ZL1	TO-92	2000 Ammo Pack

#### PACKAGE DIMENSIONS

TO-92 CASE 29-11 **ISSUE AL** 



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

CONTROLLING DIMENSION: INCH. 2 CONTOUR OF PACKAGE BEYOND DIMENSION R

3. IS UNCONTROLLED. LEAD DIMENSION IS UNCONTROLLED IN P AND

BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.115		2.93	
V	0.135		3.43	

STYLE 22: PIN 1. SOURCE 2. GATE 3 DRAIN

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